

MAX328/MAX329

Features

- ◆ Ultra-Low "Off" and "On" Leakage: 1pA Typ
- ◆ Bi-Directional Operation (Use as Mux or Demux)
- ◆ TTL and CMOS Logic Compatibility
- ◆ Analog-Signal Range Includes Power-Supply Rails
- ◆ Switching Speeds Less Than 1.5μs
- ◆ Pin Compatible With DG508/DG509 and MAX358/MAX359
- ◆ Latch-Up Proof Construction

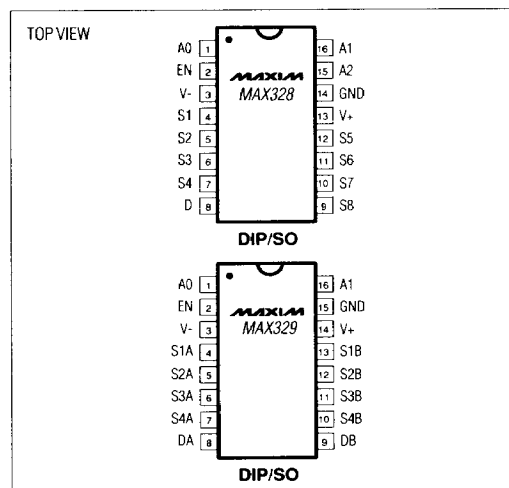
Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX328CPE	0°C to +70°C	16 Plastic DIP
MAX328CWE	0°C to +70°C	16 Wide SO
MAX328CJE	0°C to +70°C	16 Cerdip
MAX328C/D*	0°C to +70°C	Dice
MAX328EPE	-40°C to +85°C	16 Plastic DIP
MAX328EWE	-40°C to +85°C	16 Wide SO
MAX328EJE	-40°C to +85°C	16 Cerdip
MAX328MJE	-55°C to +125°C	16 Cerdip

* Contact factory for availability. Substrate may be allowed to float or be tied to V+.
Ordering information continued on page 7.

Pin Configurations

Typical Operating Circuit



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Ultra-Low Leakage Monolithic CMOS Analog Multiplexers

ABSOLUTE MAXIMUM RATINGS

Voltage Referenced to V-

V+	+44V
GND	+25V
Digital Inputs (Note 1), Vs, Vo	-2V to (V+ + 2V)
Current (Any Terminal, Except S or D)	30mA
Continuous Current, S or D	10mA
Peak Current, S or D (Pulsed at 1ms, 10% Duty Cycle Max)	40mA

Operating Temperature Range:

MAX328/329 C	-40°C to +70°C
MAX328/329 E	-40°C to +85°C
MAX328/329 M	-55°C to +125°C

Power Dissipation (Package) (Note 1)

16-Pin Cerdip (Note 2)	900mW
16-Pin Plastic DIP (Note 3)	470mW
16-Pin Wide SO (Note 4)	750mW
Storage Temperature	-65°C to +150°C

Stresses listed under "Absolute Maximum Ratings" may be applied (one at a time) to devices without resulting in permanent damage. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V+ = +15V, V- = -15V, GND = 0V, TA = +25°C, unless otherwise noted.)

PARAMETER		SYMBOL	TEST CONDITIONS		LIMITS						UNITS
					MAX328M MAX329M			MAX328C/E MAX329C/E			
					MIN	TYP	MAX	MIN	TYP	MAX	
SWITCH											
Analog-Signal Range		V _{ANALOG}			±15				± 15		V
Drain-Source On Resistance		r _{DS(on)}	V _D = 10V, I _S = 100μA	Seq. Each Switch On VAL = 0.8V VAH = 2.4V	1.5 2.5		1.5 3.5				kΩ
			V _D = -10V, I _S = 100μA		1.0 2.5		1.0 3.5				
Greatest Change In Drain-Source On- Resistance Between Channels		Δr _{DS(on)}	Δr _{DS(on)} = ($\frac{r_{DS(on) \text{ Max}} - r_{DS(on) \text{ Min}}}{r_{DS(on) \text{ Ave}}}$) -10V ≤ V _S ≤ +10V		2		2				%
Source-Off Leakage Current (Note 5)		I _{S(off)}	V _S = 10V, V _D = -10V	V _{EN} = 0V	0.1 ±10		1 ±50				pA
			V _S = -10V, V _D = 10V		0.3 ±10		0.3 ±50				
Drain-Off Leakage Current (Note 5)	MAX328	I _{D(off)}	V _D = 10V, V _S = -10V	V _{EN} = 0V	0.3 ±20		0.3 ±50				pA
			V _D = -10V, V _S = 10V		1.0 ±20		1.0 ±50				
			V _D = 10V, V _S = -10V		0.3 ±10		0.3 ±25				
	MAX329		V _D = -10V, V _S = 10V		0.5 ±10		0.5 ±25				
Drain-On Leakage Current (Note 5)	MAX328	I _{D(on)}	V _{S(all)} = V _D = 10V	Seq. Each Switch On VAL = 0.8V VAH = 2.4V	3.0 ±50		3.0 ±100				pA
			V _{S(all)} = V _D = -10V		2.0 ±50		2.0 ±100				
			V _{S(all)} = V _D = 10V		1.5 ±25		1.5 ±50				
	MAX329		V _{S(all)} = V _D = -10V		1.0 ±25		1.0 ±50				

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ELECTRICAL CHARACTERISTICS (continued)

(V+ = +15V, V- = -15V, GND = 0V, TA = +25°C, unless otherwise noted.)

PARAMETER		SYMBOL	TEST CONDITIONS		LIMITS						UNITS
					MAX328M MAX329M			MAX328C/E MAX329C/E			
					MIN	TYP	MAX	MIN	TYP	MAX	
INPUT											
Address Input Current, Input Voltage High		IAH	VA = 2.4V		.001 ±1		.001 ±1		μA		
			VA = 15V		.001 ±1		.001 ±1				
Address Input Current, Input Voltage Low		IAL	VEN = 2.4V	All VA = 0V	.001 ±1		.001 ±1		μA		
			VEN = 0V		.001 ±1		.001 ±1				
DYNAMIC											
Switching Time Of Multiplexer		ttransition	See Figure 1		1.0		1.5		μs		
Break-Before-Make Interval		topen	See Figure 2		0.2		0.2		μs		
Enable Turn-On Time		ton(EN)	See Figure 3		1.0		1.5		μs		
Enable Time-Off Time		toff(EN)	See Figure 3		0.7		1.0		μs		
OFF Isolation		OIRR	VEN = 0V, RL = 1kΩ, CL = 15pF VS = 7VRMS, f = 500kHz		84		84		dB		
Source-Off Capacitance		CS(off)	VS = 0V	VEN = 0V, f = 1MHz	1.8		1.8		pF		
Drain-Off Capacitance	MAX328	CD(off)	VD = 0V	VEN = 0V, f = 1MHz	8.0		8.0		pF		
	MAX329				4.0		4.0				
Charge Injection		Q(inj)	VA = +10V		2		2		pC		
			VA = 0V		3		3				
			VA = -10V		4		4				
SUPPLY											
Positive Supply Current		I+	VEN = 2.4V	VA = 0V/5V	4.5 200		4.5 200		μA		
Negative Supply Current		I-	VEN = 2.4V	VA = 0V/5V	1 -100		1 -100				
Power-Supply Range For Continuous Operation (Note 6)		VOP			±5 ±18		±5 ±18		V		

Note 1: All leads soldered or welded to PC board.

Note 2: Derate 12mW/°C above +75°C.

Note 3: Derate 6.3mW/°C above +75°C.

Note 4: Derate 10mW/°C above +75°C.

Note 5: Leakage parameters IS(Off), IO(Off), and IO(On) are sample tested for M suffix devices at +25°C. The E and C suffix devices are guaranteed at +25°C, but not production tested.

Note 6: Electrical characteristics, such as On Resistance, will change when power supplies other than ±15V are used. Power-supply range is a design characteristic, not production tested.

Typical values are for DESIGN AID ONLY, not guaranteed or subject to production testing.

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ELECTRICAL CHARACTERISTICS (Over Temperature)

(V+ = +15V, V- = -15V, GND = 0V, TA = TMIN to TMAX, unless otherwise noted.)

PARAMETER		SYMBOL	TEST CONDITIONS		LIMITS						UNITS
					MAX328M MAX329M			MAX328C/E MAX329C/E			
					MIN	TYP	MAX	MIN	TYP	MAX	
SWITCH											
Analog-Signal Range		VANALOG			±15		±15		V		
Drain-Source On Resistance		r _{DS(on)}	V _D = 10V, I _S = 100μA	Seq. Each Switch On V _{AL} = 0.8V, V _{AH} = 2.4V	2.2 4		1.9 5		kΩ		
			V _D = -10V, I _S = 100μA		1.5 4		1.2 5				
Source-Off Leakage Current (Note 7)		I _{S(off)}	V _S = 10V, V _D = -10V	V _{EN} = 0V	±5		±5		nA		
			V _S = -10V, V _D = 10V		±5		±5				
Drain-Off Leakage Current (Note 7)	MAX328	I _{D(off)}	V _D = 10V, V _S = -10V	V _{EN} = 0V	±20		±20		nA		
	MAX329		V _D = -10V, V _S = 10V		±20		±20				
			V _D = 10V, V _S = -10V		±10		±10				
			V _D = -10V, V _S = 10V		±10		±10				
Drain-On Leakage Current (Note 7)	MAX328	I _{D(on)}	V _{S(all)} = V _D = 10V	Seq. Each Switch On V _{AL} = 0.8V V _{AH} = 2.4V	±20		±20		nA		
	MAX329		V _{S(all)} = V _D = -10V		±20		±20				
			V _{S(all)} = V _D = 10V		±10		±10				
			V _{S(all)} = V _D = -10V		±10		±10				
INPUT											
Address Input Current, Input Voltage High		I _{AH}	V _A = 2.4V		.01 ±1		.01 ±1		μA		
			V _A = 15V		.01 ±1		.01 ±1				
Address Input Current, Input Voltage Low		I _{AL}	V _{EN} = 2.4V	All V _A = 0V	.01 ±1		.01 ±1		μA		
			V _{EN} = 0V		.01 ±1		.01 ±1				

Note 7: Leakage parameters are 100% tested at maximum rated operating temperature, i.e., +70°C, etc.

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TRUTH TABLE - MAX328

A ₂	A ₁	A ₀	EN	ON SWITCH
X	X	X	0	NONE
0	0	0	1	1
0	0	1	1	2
0	1	0	1	3
0	1	1	1	4
1	0	0	1	5
1	0	1	1	6
1	1	0	1	7
1	1	1	1	8

TRUTH TABLE - MAX329

A ₁	A ₀	EN	ON SWITCH
X	X	0	NONE
0	0	1	1
0	1	1	2
1	0	1	3
1	1	1	4

Note: Logic "0" = $V_{AL} \leq 0.8V$, Logic "1" = $V_{AH} \geq 2.4V$

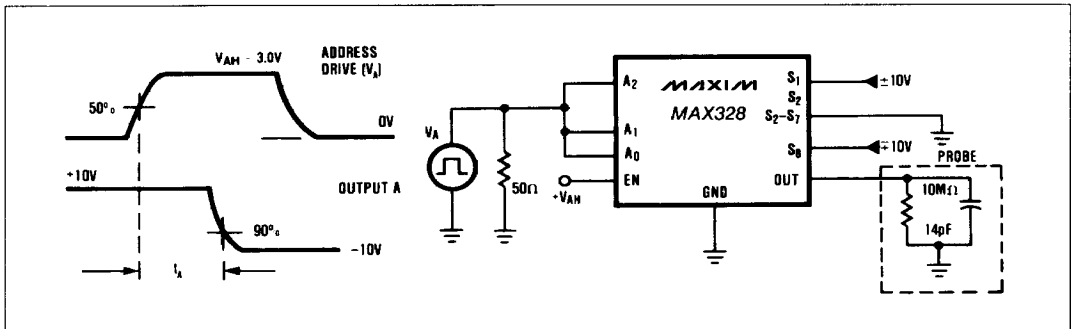


Figure 1. Access Time vs. Logic Level (High)

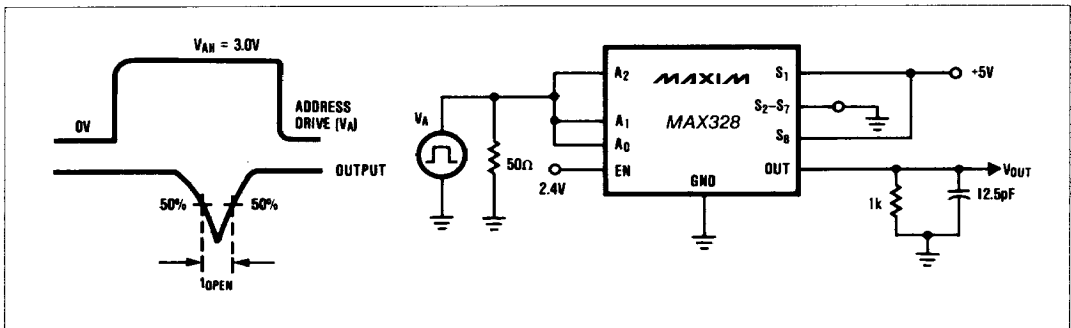


Figure 2. Break-Before-Make Delay (t_{OPEN})

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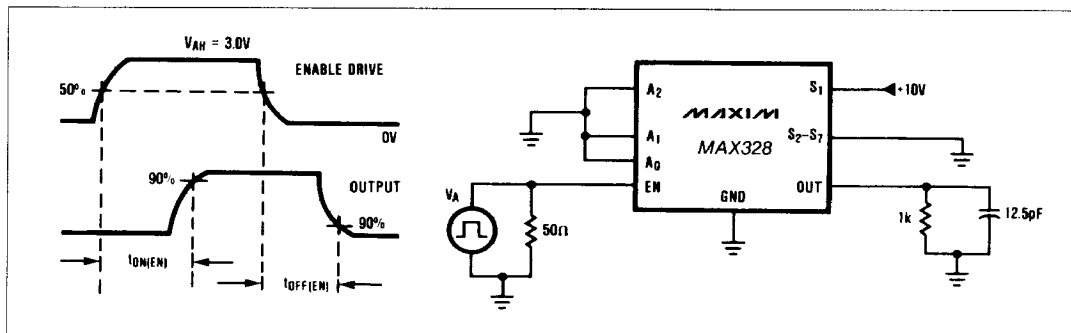
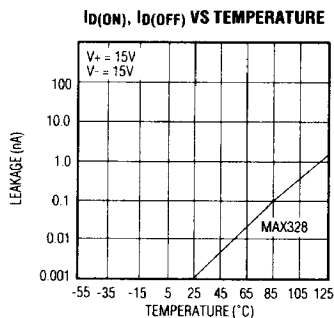
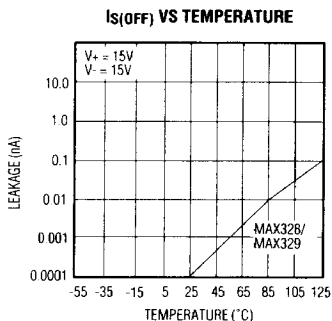
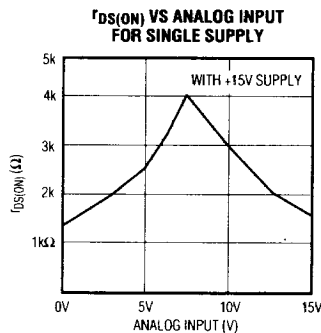
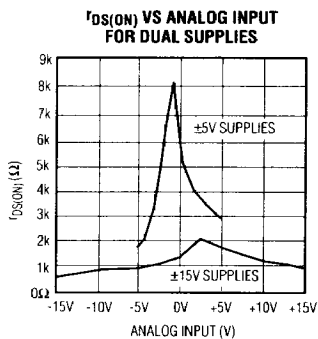


Figure 3. Enable Delay ($t_{ON(EN)}$, $t_{OFF(EN)}$)

Typical Operating Characteristics



Ultra-Low Leakage Monolithic CMOS Analog Multiplexers

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Application Notes

Figure 4 is a typical circuit for converting the MAX328/MAX329 into a fault-tolerant mux. In this application, the internal diodes limit the voltage at the MAX328 input to $\pm 15.7V$ ($\pm 15V$ supplies). No external diodes need to be added with the MAX328/MAX329, unlike conventional multiplexers requiring external diodes.

The resistors, R , need to be $39k\Omega$ or higher to limit the power dissipation in the resistor when a 120V AC fault occurs (i.e., power dissipation is $(120-16)^2/39k\Omega$ or 0.28W. This is why a 1/2W resistor is needed). The circuit withstands an indefinite fault to a 120V AC line with no damage to any component.

The guaranteed low leakage of the MAX328 is the key to this application. For the 10pA max $I_s(\text{off})$, the measurement error is $10pA \times 39k = 0.39\mu V$ at room temperature. At 125°C, the leakages increase by a factor of 100; thus, $39\mu V$ is the high-temperature error. The commercial and industrial grades have a maximum leakage of 50pA of $I_s(\text{off})$ at room temperature. Therefore, 1.95 μV is the room temperature error, and 195 μV is the high-temperature (125°C) error.

Now, 17-bit accuracy decreases to 76 μV for the least significant bit. Our 10pA model will meet this at 125°C, but not the 50pA model. Therefore, the 10pA model could be used in 16-bit systems over the military temperature range, but the 50pA model would be restricted to 100°C with adequate guardband.

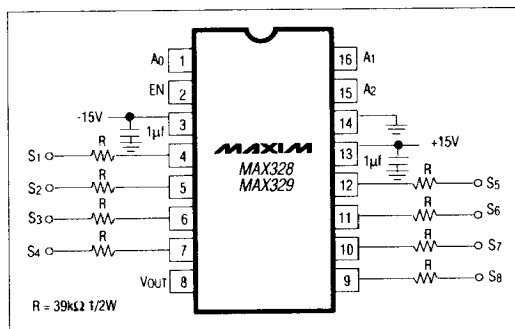


Figure 4. Fault-tolerant MUX (indefinitely withstands 120V AC fault voltages)

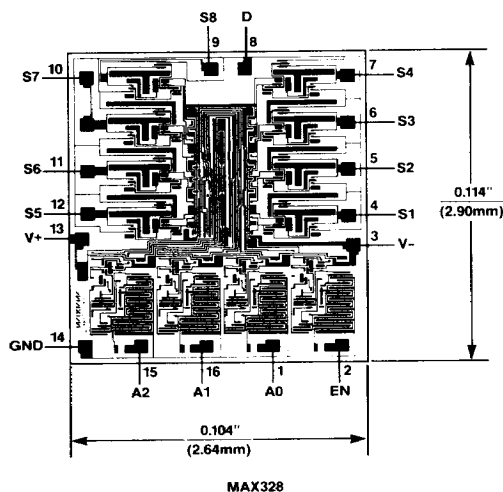
Ordering Information (continued)

PART	TEMP. RANGE	PIN-PACKAGE
MAX329CPE	0°C to +70°C	16 Plastic DIP
MAX329CWE	0°C to +70°C	16 Wide SO
MAX329CJE	0°C to +70°C	16 CERDIP
MAX329C/D*	0°C to +70°C	Dice
MAX329EPE	-40°C to +85°C	16 Plastic DIP
MAX329EWE	-40°C to +85°C	16 Wide SO
MAX329EJE	-40°C to +85°C	16 CERDIP
MAX329MJE	-55°C to +125°C	16 CERDIP

* Contact factory for availability. Substrate may be allowed to float or be tied to V+.

Chip Topographies

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